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Wireless Control Components



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TDK5100F

434 MHz ASK/FSK Transmitter in 10-pin Package

Wireless Control Components



TDK5100F

Revision History:		2008-04-04	V 1.2
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Page Subjects (major changes since last revision)			
31-33, 35	31-33, 35 Added Min/Maxvalues of output power and supply current		
31, 33, 35 Added value range		es of frequency range and for possible extension of	frequency
-			

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Product Description

1 Product Description

1.1 Overview

The TDK 5100 F is a single chip ASK/FSK transmitter for operation in the frequency band 433-435 MHz. The IC offers a high level of integration and needs only a few external components. The device contains a fully integrated PLL synthesizer and a high efficiency power amplifier to drive a loop antenna. A special circuit design and an unique power amplifier design are used to save current consumption and therefore to save battery life. Additional features are a power down mode and a divided clock output.

1.2 Features

- · fully integrated frequency synthesizer
- VCO without external components
- · ASK and FSK modulation
- frequency range 433-435 MHz
- high efficiency power amplifier (typically 5 dBm)
- low supply current
- voltage supply range 2.1 ... 4 V
- temperature range –40 ... +125°C
- power down mode
- crystal oscillator 13.56 MHz
- FSK-switch
- divided clock output for µC
- low external component count

1.3 Application

- Tire pressure monitoring systems
- Keyless entry systems
- Remote control systems
- Alarm systems
- · Communication systems

1.4 Order Information

Table 1 Order Information

Туре	Ordering Code	Package	
TDK5100F	SP000014745	PG-TSSOP-10	
available on tape and reel			



2 Functional Description

2.1 Pin Configuration

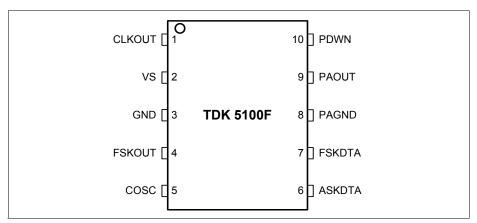


Figure 1 IC Pin Configuration

2.2 Pin Definition and Functions

Table 2 Pin Definition and Functions - Overview

Pin No.	Symbol	Function	
1	CLKOUT	Clock Driver Output (847.5 kHz)	
2	VS	Voltage Supply	
3	GND	Ground	
4	FSKOUT	Frequency Shift Keying Switch Output	
5	cosc	Crystal Oscillator Input (13.56 MHz)	
6	ASKDTA	Amplitude Shift Keying Data Input	
7	FSKDTA	Frequency Shift Keying Data Input	
8	PAGND	Power Amplifier Ground	
9	PAOUT	Power Amplifier Output (434 MHz)	
10	PDWN	Power Down Mode Control	



Table 3 Pin Definition and Function¹⁾

Pin No.	Symbol	Interface Schematic	Function
1	CLKOUT	ν _s ο 1	Clock output to supply an external device. An external pull-up resistor has to be added in accordance to the driving requirements of the external device. The clock frequency is 847.5 kHz.
2	VS		This pin is the positive supply of the transmitter electronics. An RF bypass capacitor should be connected directly to this pin and returned to GND (pin 3) as short as possible.
3	GND		General ground connection.
4	FSKOUT	V _s V _s V _s V _s 1200 μΩ 2000 κΩ 2	This pin is connected to a switch to GND (pin 3). The switch is closed when the signal at FSKDTA (pin 7) is in a logic low state. The switch is open when the signal at FSKDTA (pin 7) is in a logic high state. FSKOUT can switch an additional capacitor to the reference crystal network to pull the crystal frequency by an amount resulting
			in the desired FSK frequency shift of the transmitter output frequency.



Pin No.	Symbol	Interface Schematic	Function
5	COSC	V _S V _S 5 100 μA 5	This pin is connected to the reference oscillator circuit. The reference oscillator is working as a negative impedance converter. It presents a negative resistance in series to an inductance at the COSC pin.
6	ASKDTA	90 kΩ +1.2 V 0+1.1 V 50 pF 30 μA	Digital amplitude modulation can be imparted to the Power Amplifier through this pin. A logic high (ASKDTA > 1.5 V or open) enables the Power Amplifier. A logic low (ASKDTA < 0.5 V) disables the Power Amplifier.



Pin No.	Symbol	Interface Schematic	Function
7	FSKDTA	V _S +1.2 V 90 kΩ 60 kΩ 30 μA	Digital frequency modulation can be imparted to the Xtal Oscillator by this pin. The VCO-frequency varies in accordance to the frequency of the reference oscillator. A logic high (FSKDTA > 1.5V or open) sets the FSK switch to a high impedance state. A logic low (FSKDTA < 0.5 V) closes the FSK switch from FSKOUT (pin 4) to GND (pin 3). A capacitor can be switched to the reference crystal network this way. The Xtal Oscillator frequency will be shifted giving the designed FSK frequency deviation.

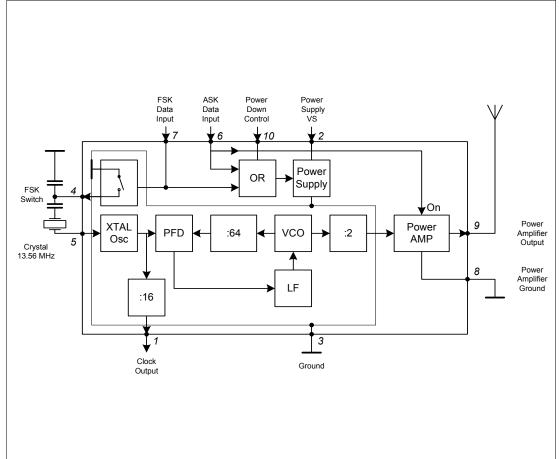


Pin No.	Symbol	Interface Schematic	Function			
8	PAGND	9	Ground connection of the power amplifier. The RF ground return path of the power amplifier output PAOUT (pin 9) has to be concentrated to this pin.			
9	PAOUT	***************************************	RF output pin of the transmitter. A DC path to the positive supply VS has to be supplied by the antenna matching network.			
10	PDWN	, V _s	Disable pin for the complete transmitter circuit.			
		40 μA * (ASKDTA+FSKD 5 kΩ "ON"			40 μA * (ASKDTA+FSKDTA)	A logic low (PDWN < 0.7 V) turns off all transmitter functions.
			10 "ON"	A logic high (PDWN > 1.5 V) gives access to all transmitter functions.		
		250 κΩ	PDWN input will be pulled up by 40 µA internally by either setting FSKDTA or ASKDTA to a logic high-state.			

¹⁾ Indicated voltages and currents apply for PLL Enable Mode and Transmit Mode. In Power Down Mode, the values are zero or high-ohmic.



2.3 Functional Block Diagram



7



2.4 Functional Block Description

2.4.1 PLL Synthesizer

The Phase Locked Loop synthesizer consists of a Voltage Controlled Oscillator (VCO), an asynchronous divider chain, a phase detector, a charge pump and a loop filter. It is fully implemented on chip. The tuning circuit of the VCO consisting of spiral inductors and varactor diodes is on chip, too. Therefore no additional external components are necessary. The nominal center frequency of the VCO is 868 MHz. The oscillator signal is fed both, to the synthesizer divider chain and to the power amplifier. The overall division ratio of the asynchronous divider chain is 64. The phase detector is a Type IV PD with charge pump. The passive loop filter is implemented on chip.

2.4.2 Crystal Oscillator

The crystal oscillator operates at 13.56 MHz.

The crystal frequency is divided by 16. The resulting 847.5 kHz are available at the clock output CLKOUT (pin1) to drive the clock input of a micro controller.

To achieve FSK transmission, the oscillator frequency can be detuned by a fixed amount by switching an external capacitor via FSKOUT (pin 4).

The state of the switch is controlled by the signal at FSKDTA (pin 7).

Table 4 FSKDTA - FSK Switch

FSKDTA (pin7)	FSK Switch
Low ¹⁾	CLOSED
Open ²⁾ , High ³⁾	OPEN

1) Low: Voltage at pin < 0.5V

2) Open: Pin open

3) High: Voltage at pin > 1.5V

2.4.3 Power Amplifier

The VCO frequency is divided by 2 and fed to the Power Amplifier.

The Power Amplifier can be switched on and off by the signal at ASKDTA (pin 6).



Table 5 ASKDTA - Power Amplifier

ASKDTA (pin6)	Power Amplifier
Low ¹⁾	OFF
Open ²⁾ , High ³⁾	ON

1) Low: Voltage at pin < 0.5V

2) Open: Pin open

3) High: Voltage at pin > 1.5V

The Power Amplifier has an Open Collector output at PAOUT (pin 9) and requires an external pull-up coil to provide bias. The coil is part of the tuning and matching LC circuitry to get best performance with the external loop antenna. To achieve the best power amplifier efficiency, the high frequency voltage swing at PAOUT (pin 9) should be twice the supply voltage.

The power amplifier has its own ground pin PAGND (pin 8) in order to reduce the amount of coupling to the other circuits.

2.4.4 Power Modes

The IC provides three power modes, the POWER DOWN MODE, the PLL ENABLE MODE and the TRANSMIT MODE.

2.4.4.1 Power Down Mode

In the POWER DOWN MODE the complete chip is switched off.

The current consumption is typically 0.3 nA at 3 V 25°C.

This current doubles every 8°C. The values for higher temperatures are typically 14 nA at 85°C and typically 600 nA at 125°C.

2.4.4.2 PLL Enable Mode

In the PLL ENABLE MODE the PLL is switched on but the power amplifier is turned off to avoid undesired power radiation during the time the PLL needs to settle. The turn on time of the PLL is determined mainly by the turn on time of the crystal oscillator and is less than 1 ms when the specified crystal is used.

The current consumption is typically 3.5 mA (in PLL Enable Mode).



2.4.4.3 Transmit Mode

In the TRANSMIT MODE the PLL is switched on and the power amplifier is turned on too.

The current consumption of the IC is typically 7 mA when using a proper transforming network at PAOUT, see Figure 8.

2.4.4.4 Power mode control

The bias circuitry is powered up via a voltage V > 1.5 V at the pin PDWN (pin10). When the bias circuitry is powered up, the pins ASKDTA and FSKDTA are pulled up internally.

Forcing the voltage at the pins low overrides the internally set state.

Alternatively, if the voltage at ASKDTA or FSKDTA is forced high externally, the PDWN pin is pulled up internally via a current source. In this case, it is not necessary to connect the PDWN pin, it is recommended to leave it open.

The principle schematic of the power mode control circuitry is shown in Figure 3

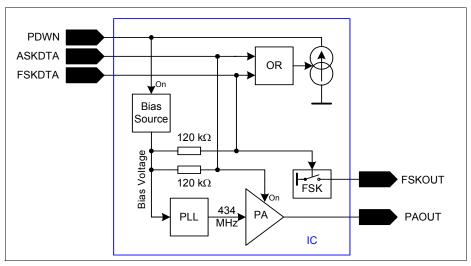


Figure 3 Power mode control circuitry



Table 6 provides a listing of how to get into the different power modes

Table 6 Power Modes

PDWN	FSKDTA	ASKDTA	MODE
Low ¹⁾	Low, Open	Low, Open	POWER DOWN
Open ²⁾	Low	Low	
High ³⁾	Low, Open, High	Low	PLL ENABLE
Open	High	Low	
High	Low, Open, High	Open, High	TRANSMIT
Open	High	Open, High	
Open	Low, Open, High	High	

1) Low: Voltage at pin < 0.7V (PDWN)

Voltage at pin < 0.5V (FSKDTA, ASKDTA)

2) Open: Pin open

3) High: Voltage at pin > 1.5V

Other combinations of the control pins PDWN, FSKDTA and ASKDTA are not recommended.



2.4.5 Recommended Timing Diagrams for ASK- and FSK-Modulation

ASK Modulation using FSKDTA and ASKDTA, PDWN not connected

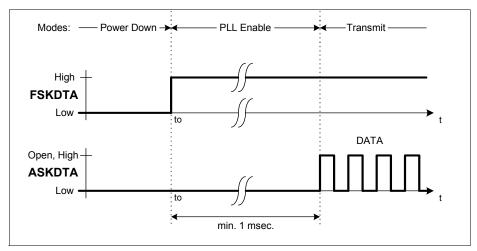


Figure 4 ASK Modulation

FSK Modulation using FSKDTA and ASKDTA, PDWN not connected.

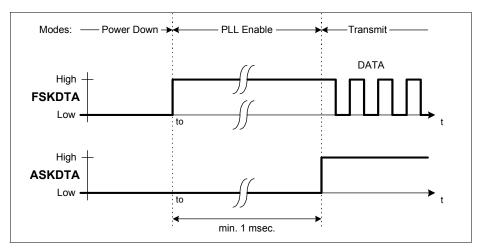


Figure 5 FSK Modulation



Alternative ASK Modulation, FSKDTA not connected.

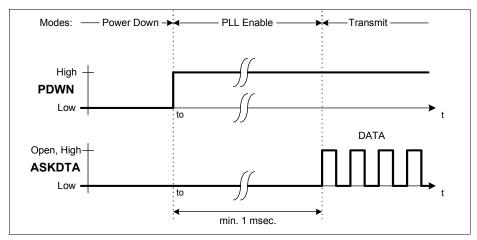


Figure 6 Alternative ASK Modulation

Alternative FSK Modulation

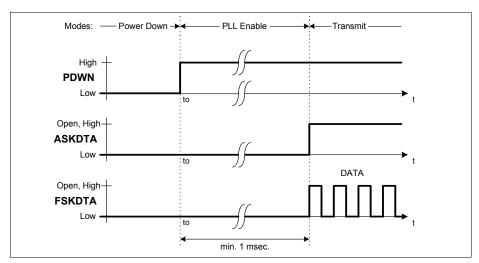


Figure 7 Alternative FSK Modulation



3 Applications

3.1 50 Ohm-Output Testboard Schematic

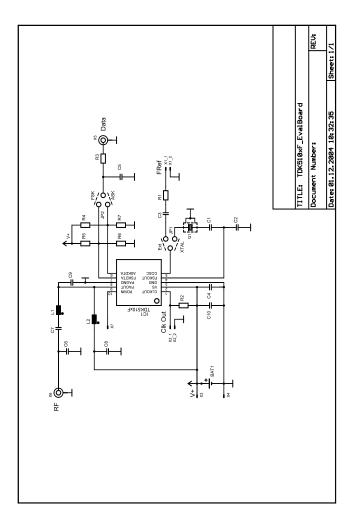


Figure 8 50 Ohm-output testboard schematic

3.2 50 Ohm-Output Testboard Layout

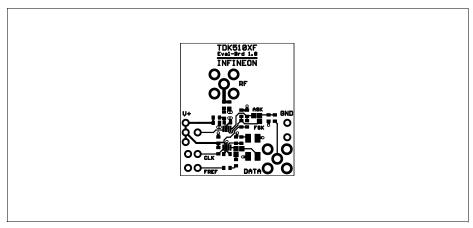


Figure 9 Top Side of TDK5100 F-Testboard with 50 Ohm-Output

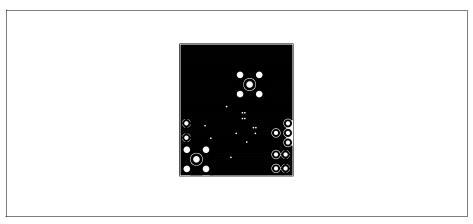


Figure 10 Bottom Side of TDK5100 F-Testboard with 50 Ohm-Output



3.3 Bill of Material (50 Ohm-Output Evalboard)

Reference	Value	Specification
R1	open	
R2	open	
R3	4k7	0603, +/-5%
R4	12k	0603, +/-5%
R5	open	
R6	15k	0603, +/-5%
R7	open	
C1	10p	0603, C0G, +/-1%
C2	6p8	0603, C0G, +/-0,1p
C3	open	
C4	open	
C5	100p	0603, X7R, +/-10%
C6	12p	0603, C0G, +/-1%
C7	39p	0603, C0G, +/-1%
C8	330p	0603, C0G, +/-5%
C9	3p3	0603, C0G, +/-0,1p
C10	47n	0603, X7R, +/-10%
L1	47n	EPCOS SIMID 0603-C, +/-2%
L2	120n	EPCOS SIMID 0603-C, +/-2%
X1	n.e.	
X2	n.e.	
X3	Pin	single-pole connector, 2,54mm
X4	Pin	single-pole connector, 2,54mm
X5	SMA-connector	
X6	SMA-connector	
X7	n.e.	
JP1	solder bridge	in position "XTAL"
JP2	solder bridge	in position "FSK"
Q1	13,56875 MHz,	Tokyo Denpa TSS-3B 13,56875 MHz Spec.No. 10-50205
IC1	TDK5100F	

Please note:

If R2 is placed (Clk Out is activated) a 47nF capacitor has to be used for C4.

3.4 Stripline-Antenna Testboard Schematic

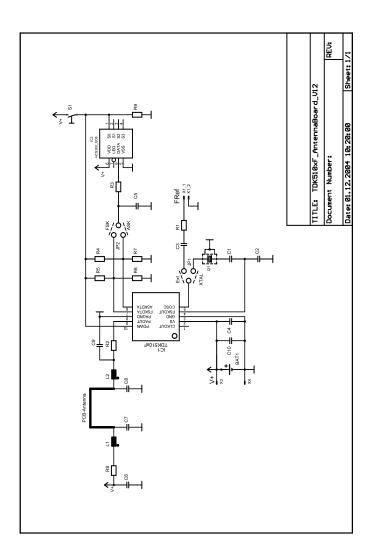


Figure 11 Stripline-antenna testboard schematic

3.5 Stripline-Antenna Testboard Layout

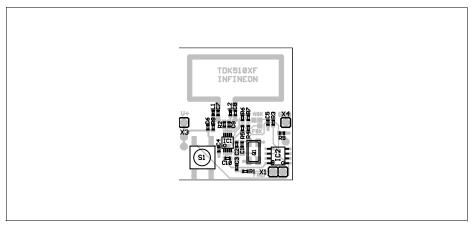


Figure 12 Top Side of TDK5100 F-Testboard with Stripline-Antenna

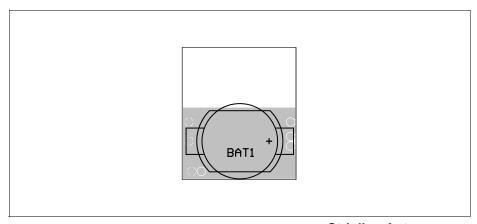


Figure 13 Bottom Side of TDK5100 F-Testboard with Stripline-Antenna

Please note that this board layout may be used for both high- and low-power applications, see also the bill of materials on the subsequent pages.

In case of ASK operation the solder bridge JP2 has to be shortened in the "ASK"-position, in case of FSK modulation in the "FSK" position.

Solder bridge JP1between C1, C2 and C3) gives a choice of operating the board with the on-board crystal as reference ("XTAL" shortened, i.e. close to C1 and C2) or with an external clock generator (solder bridge shorts pads between C3 and C2).



3.6 Bill of Material (Antenna board) FSK modulation

Reference	Value	Specification
R1	open	
R2	0R	0603, SMD-Jumper
R3	0R	0603, SMD-Jumper
R4	82k	0603, +/-5%
R5	open	
R6	open	
R7	100n	0603, X7R, +/-10%
R8	39R	0603, +/-1%
R9	15k	0603, +/-5%
C1	10p	0603, C0G, +/-1%
C2	6p8	0603, C0G, +/-0,1p
C3	open	
C4	open	
C5	open	
C6	10n	0603, X7R, +/-10%
C7	5p6	0603, C0G, +/-0,1p
C8	open	
C9	4p7	0603, C0G, +/-0,1p
C10	47n	0603, X7R, +/-10%
L1	100n	0603, EPCOS SIMID, +/-2%
L2	0R	0603, SMD-Jumper
X1	n.e.	
X3	n.e.	
X4	n.e.	
S1	push-button	STTSKHMPW, ALPS
JP1	solder bridge	in position "XTAL"
JP2	solder bridge	in position "FSK"
Q1	13,56875 MHz,	Tokyo Denpa TSS-3B 13,56875 MHz Spec.No. 10-
IC1	TDK5100F	P-TSSOP-10
IC2	HCS360	SO8
BAT1	battery holder	HU2031-1, Renata
	battery	CR2032, Renata

3.7 Application Hints on the Crystal Oscillator

Application Hints on the crystal oscillator

The crystal oscillator achieves a turn on time less than 1 msec when the specified crystal is used. To achieve this, a NIC oscillator type is implemented in the TDK 5100 F. The input impedance of this oscillator is a negative resistance in series to an inductance. Therefore the load capacitance of the crystal CL (specified by the crystal supplier) is transformed to the capacitance Cv.

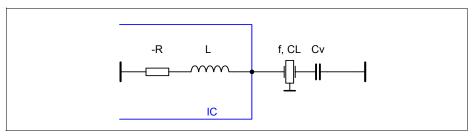


Figure 14 Application Hints

Formula 1:

$$Cv = \frac{1}{\frac{1}{CL} + \omega^2 L}$$

CL: crystal load capacitance for nominal frequency

ω: angular frequency

L: inductance of the crystal oscillator

Example for the ASK-Mode:

Referring to the application circuit, in ASK-Mode the capacitance C2 is replaced by a short to ground. Assume a crystal frequency of 13.56MHz and a crystal load capacitance of CL = 12 pF. The inductance L at 13.56MHz is about 4.6 μ H. Therefore C1 is calculated to 10 pF.

$$Cv = \frac{1}{\frac{1}{CL} + \omega^2 L} = C1$$